GOKULKRISHNA MUTHUSAMY

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Graduating May, 2025. Looking for full time opportunities Education

New York University (Courant), New York, NY Master of Science in Computer Science National Institute of Technology (NIT), Tiruchirappalli, TN Bachelor of Technology in Computer Science and Engineering

Experience

Machine Learning Intern, AMD, San Jose, CA

Masters Tech - AI Engine Driver Team, AMD Adaptive Edge Computing Team.

- Developed prototype compiler using MLIR and Clang Frontend, simplifying AI Engine (NPU) programming by emitting optimized driver APIs. The tool captures AI Engine driver parameters and data structures using ClangAST and uses MLIR (Types, Attributes and Operation) to emit code.
- Fixed the Routing API for NPU Tiles by resolving errors, and bugs and writing unit tests for edge cases. This resulted in the Upstreaming of the API for the AI engine runtime driver codebase for Versal Adaptive SoC. Apr 2022 – Aug 2023

Senior Software Engineer, Samsung Research India, Bangalore, KA

- SNAP CPU, GPU and Compiler team for Neural Acceleration OnDevice AI.
 - Accelerating Generative AI models: Programmed OpenCL GPU kernels for complex neural layers like group normalization and updated MLIR to support TfLite model conversion from Keras, enabling complete execution of Stable Diffusion models on Mobile GPUs. Engineered optimizations like convolution splitting, Quantization, GELU approximation, and fused softmax in VAE, which resulted in a 4.58x improvement in performance over CPU. This solution will serve as a base for infrastructure development for the acceleration of Gen-AI models on Samsung Mobile GPUs. The SD model inferences at 1.2s on 512x512 image for 1 iteration on float execution.
 - Automatic Caching tool: Designed an automatic recompilation & caching tool for OpenCL kernels on GPUs to • reduce caching overhead and prevent crashes during GPU driver updates, which resulted in a 25% reduction in crash reports and a 20% increase in the productivity of engineers and the use case team. Received Spot award in Q3 2022 for developing this tool.
 - Accelerated 10 use cases on Samsung flagships (Galaxy S23) to improve user experience, achieved a 20% improvement in load time and 10% in execution time and overall performance improvement of 1.4x (S23) and 1.3x (Fold5) using ML Accelerators. Jan-2021 – Apr 2022

ML Software Engineer, Samsung Research India, Bangalore, KA

SNAP - CPU, GPU and Compiler team for Neural Acceleration - OnDevice AI.

- Framework inference Profiler: Engineered a Profiling tool for calculating the layer-wise performance of kernels in ArmNN during inference of ML model. Resulting in the faster diagnosis of performance degradation and improved the productivity of the team by 30%.
- Collaborated with Galaxy RAW (USP) team to solve greenish tinge issues on images from AINR (noise reduction) by implementing new normalization method to support float16 quantized precision execution. This improved inference time by 34% over the previous method.

Intern, Samsung Research India, Bangalore, KA

Keyboard Intelligence - OnDevice AI

Improved the emoji prediction in the Samsung keyboard by incorporating keystroke statistics in the NLP sentiment analysis algorithm, resulting in a 5% improvement in accuracy on personalized datasets.

Technical Skills

Programming Languages: C++, Python, OpenCL, CUDA, C, JavaScript, Shell, Rust, HTML, CSS Technologies: TensorFlow, Pytorch, TFLite, Keras, ArmNN, ONNX, MLIR, Clang, Apache TVM, MongoDB, RapidMiner, PostgreSQL, Quantization, LLVM.

Tools: Git, Perfetto, Gdb, Docker, FlatBuffers, Bazel, Valgrind, Asan, Hwasan, Android NDK, Perforce, JIRA.

Patents & Publications

A1 graded patent by Samsung Research HQ

OnDevice Validation: The main inventor of Systems and Methods for On-Device Validation of a Neural Network Model, this idea reduces validation memory requirement by 100% and makes the computations on-device friendly. Inventors- M Gokulkrishna, Siva Kailash, R. Prasanna, Rajath Elias, Ashok Kumar, Praveen. Pending patent: US-20240135181-A1

Sept 2023 - May 2025 4.0/4.0Jun 2020 8.6/10

[LinkedIn] [Personal Website]

May 2019 – July 2019

Oct 11, 2022

May 2024 – Present